

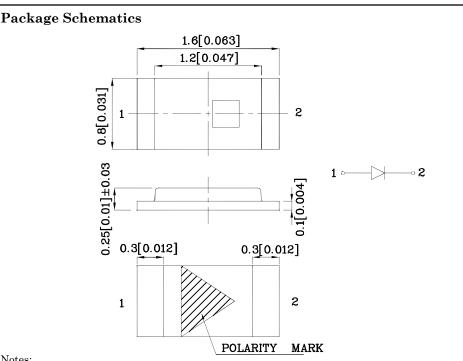
Part Number: ZMDKT53W-6

1.6X0.8mm SMD CHIP LED LAMP (0.25mm Height)

Features

- Ideal for indication light on hand held products
- Long life and robust package
- Standard Package: 2,000pcs/ Reel
- MSL (Moisture Sensitivity Level): 3
- \bullet RoHS compliant





Applications

1.Mobile phone Keypad indicator and backlight 2.Flat backlight for LCD, switch and symbol 3.Toys

Notes:

1. All dimensions are in millimeters (inches).

2. Tolerance is $\pm 0.1 (0.004")$ unless otherwise noted.

3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T _A =25°C)		MDKT (AlGaInP)	Unit	
Reverse Voltage	V_{R}	5	V	
Forward Current	\mathbf{I}_{F}	30	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	150	mA	
Power Dissipation	PD	75	mW	
Operating Temperature	$T_{\rm A}$	$-40 \sim +85$	°C	
Storage Temperature	Tstg	$-40 \sim +85$	C	

Operating Characteristics (T _A =25°C)		MDKT (AlGaInP)	Unit	
Forward Voltage (Typ.) (I _F =20mA)	$V_{\rm F}$	2.0	V	
Forward Voltage (Max.) (I _F =20mA)	V_{F}	2.5	V	
Reverse Current (Max.) $(V_R=5V)$	I_R	10	uA	
Wavelength of Peak Emission CIE127-2007*(Typ.) (I _F =20mA)	λΡ	645*	nm	
Wavelength of Dominant Emission CIE127-2007*(Typ.) $(I_F=20mA)$	λD	630*	nm	
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =20mA)	$ riangle\lambda$	20	nm	
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	35	pF	

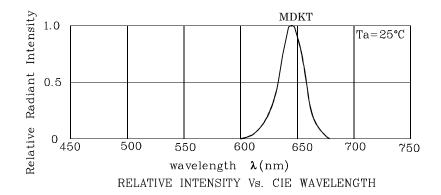
Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity CIE127-2007* (I _F =20mA) mcd		Wavelength CIE127-2007* nm λP	Viewing Angle 20 1/2
				min.	typ.		
ZMDKT53W-6	Red	AlGaInP	Water Clear	200 55*	347 108*	645*	120°

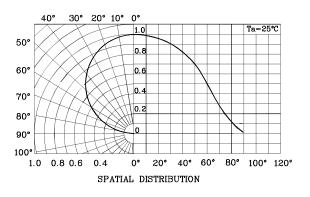
 ${\rm *Luminous\ intensity\ value\ and\ wavelength\ are\ in\ accordance\ with\ CIE127-2007\ standards.}$

Feb 12,2014

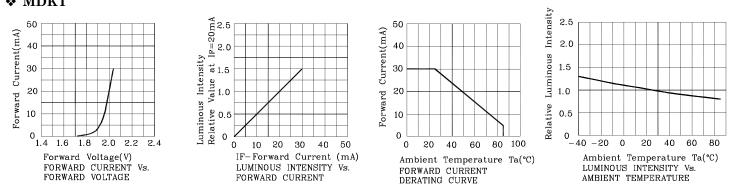
SDSA6942 V4-X Layout: Maggie L.



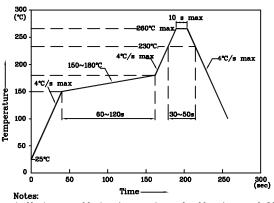




♦ MDKT



LED is recommended for reflow soldering and soldering profile is shown below.



Reflow Soldering Profile for SMD Products (Pb-Free Components)

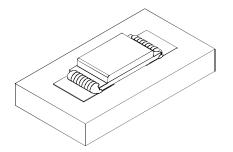
1. Maximum soldering temperature should not exceed 260°C 2.

Recommended reflow temperature: 145°C-260°C Do not put stress to the epoxy resin during З.

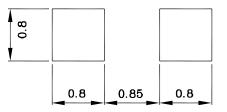
high temperatures conditions



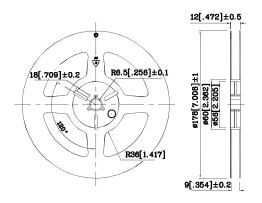
✤ The device has a single mounting surface. The device must be mounted according to the specifications.



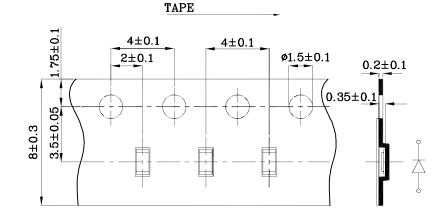
Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



Reel Dimension



Tape Specification (Units : mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

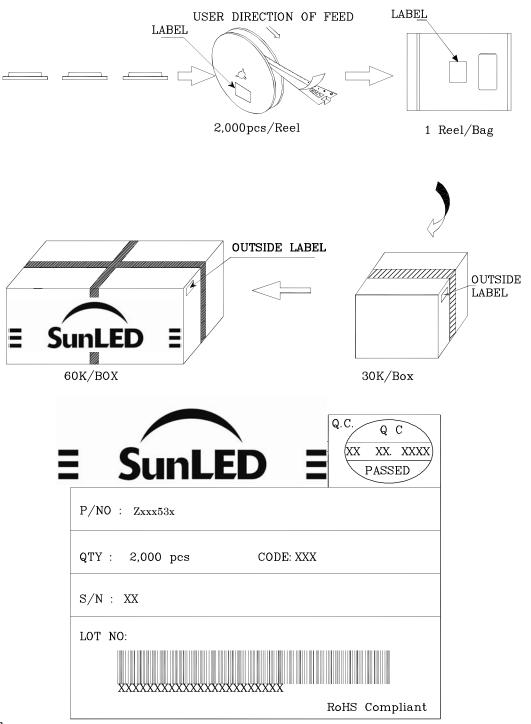
2. Luminous intensity / luminous flux: +/-15%

3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.



PACKING & LABEL SPECIFICATIONS



TERMS OF USE

- 1. Data presented in this document reflect statistical figures and should be treated as technical reference only.
- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet.
- User accepts full risk and responsibility when operating the product(s) beyond their intended specifications. 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please
- consult with a SunLED representative for special applications where the LED may have a direct impact on a person's life.
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